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2015 Q3 Investor Conference

Nov. 13th, 2015

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Outline

Business Model

- Review of Operations for Q315
- Growth Opportunity and Future Outlook
- Q & A

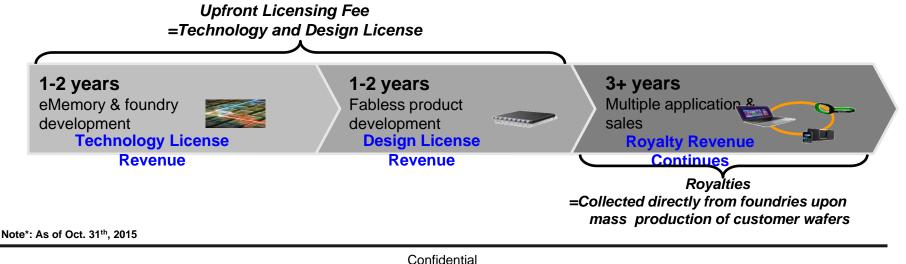


Business Model

- Founded in 2000. First customer engaged in 2002. Achieved profitability in 2005 and IPO in 2011. The largest logic non-volatile memory IP company, 224 employees (155 R&D)*.
- Since its IPO, the company initiated no new fund raising or bank debt, and has distributed in excess of 100% of earnings in cash dividends.
- Growth Indices: 1) No. of ongoing technology platforms

2) No. of design licenses

3) Royalty

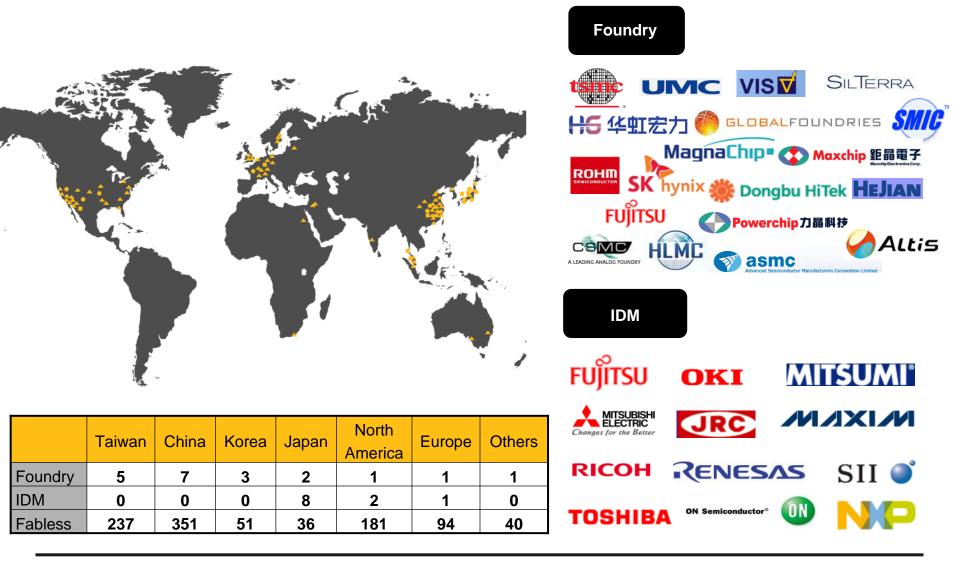


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Worldwide Customers

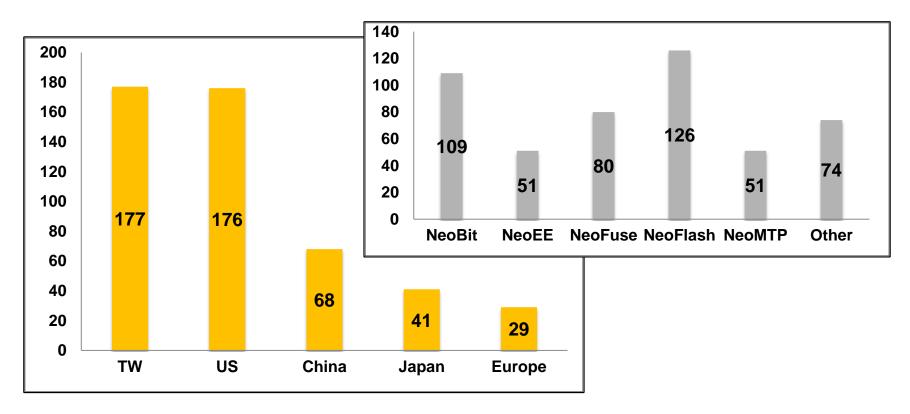




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Patent Portfolio

	Q215	Q315	Diff.
Pending	181	187	+6
Issued	287	304	+17
Total	468	491	+23

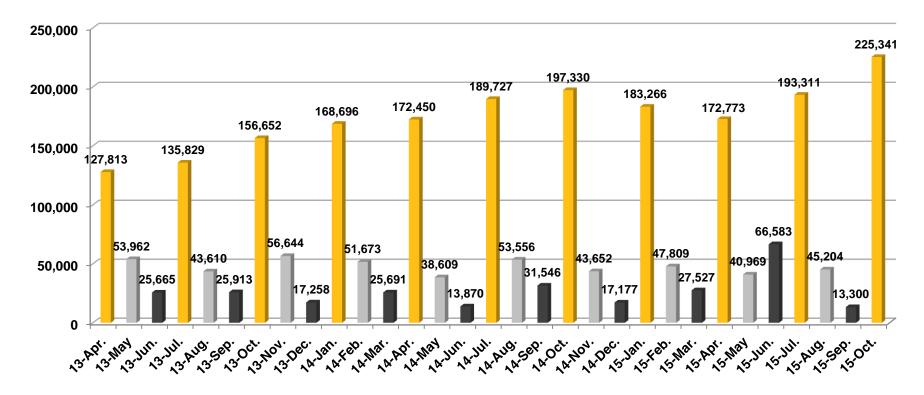


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Quarterly Revenue Pattern*

 The quarterly royalty from most of foundries are collected at first month of each quarter and from some other foundries are collected at second month, and none at third month.



Unit : NTD Thousands

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Q3 Revenue Breakdown

Unit: NTD thousands

	Q315	Q215	% change	Q314	% change	2015Q1-Q3	2014Q1-Q3	% change
Licensing	38,167	95,982	-60.24%	61,981	-38.42%	198,205	194,224	2.05%
Royalty	213,648	184,343	15.90%	212,848	0.38%	592,537	551,594	7.42%
Total	251,815	280,325	-10.17%	274,829	-8.37%	790,742	745,818	6.02%

Unit: Number of contracts

		Q315	Q215	2014	2013
Technology	/ Licenses	4	8	21	19
Design	NRE	10	17	82	51
Licenses	Usage	76	87	363	342



Financial Income Statement

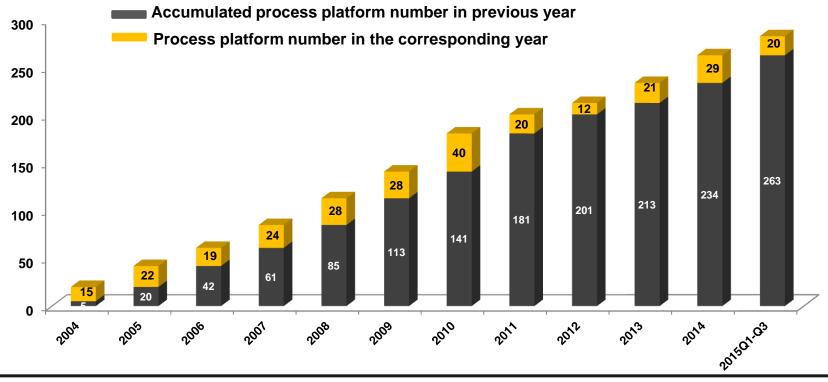
(Unit: NTD thousands)	Q315	Q215	% change	Q314	% change
Revenue	251,815	280,325	-10.17%	274,829	-8.37%
Gross Margin	100%	100%	-	100%	-
Operating Expenses	143,776	141,435	1.66%	135,695	5.96%
Operating Margin	42.9%	49.5%	-6.6ppts	50.6%	-7.7ppts
Net Income	106,301	130,297	-18.42%	124,352	-14.52%
Net Margin	42.2%	46.5%	-4.3ppts	45.2%	-3.0ppts
EPS (Unit: NTD)	1.40	1.72	-18.60%	1.64	-14.63%
ROE	24.5%	30.9%	-6.4ppts	29.7%	-5.2ppts

Technology License

Unit: Number of contract

Year	2013	2014	2015Q1-Q3
License number	19	21	17

Note: The terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.



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Current Technology Development Platforms

- Total (As of Sep.) : 83*
- 17 for NeoBit, 28 for NeoFuse, 23 for NeoEE, and 15 for NeoMTP.

	14/16nm	28nm	40nm	55/65nm	80/90nm	0.11~ 0.13um	0.15~ 0.18um	>0.25 um	Total
NeoBit	-	-	I	-	-	5	11	1	17
NeoFuse	2	6	4	8	2	4	2	-	28
NeoFlash	-	-	-	-	-	-	-	-	-
NeoEE	-	-	2	-	1	6	14	-	23
NeoMTP	-	-	1	1	2	3	8	-	15

Note*: 5 platforms qualified in Q3, 4 platforms kicked off in Q3



Current Technology Development Platforms

12" Fabs	Production	Development	NVM Type	Process Type
16nm	0	2	ОТР	FF+
28nm	4	6	ОТР	LP/HPM, HLP/HPM, LPS
40nm	2	7	OTP, MTP	HV-DDI, LP
55/65nm	10	9	OTP, MTP, Flash	LP, HV-DDI, HV-OLED, DRAM, CIS
80/90nm	5	5	OTP, MTP	HV-DDI, HV-OLED, LP
0.13/0.11um	6	4	OTP, Flash	HV-DDI, BCD, Generic
0.18um	1	0	ОТР	BCD

8" Fabs	Development	NVM Type	Process Type
0.13/0.11um	14	OTP, MTP, Flash	HV-DDI, BCD, LP, RF, CIS, LL
0.18/0.16/0.152um	35	OTP, MTP	Generic, LP, LL, MR, HV, Green, BCD
0.25um	1	OTP, MTP	BCD
0.35um	0	ОТР	UHV

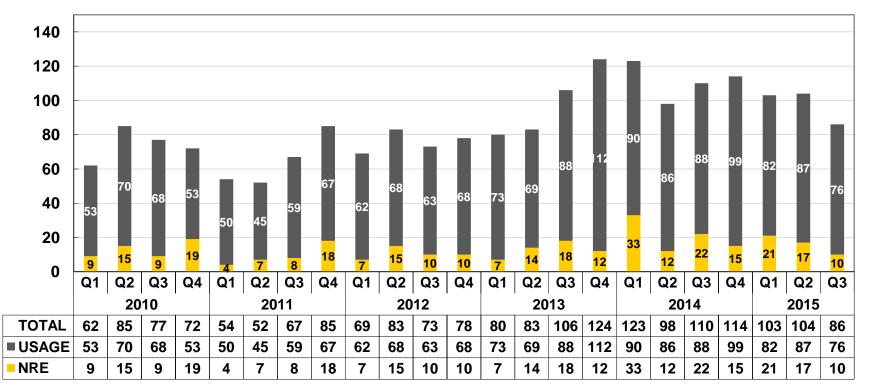
*As of Sep. 30, 2015



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Quarterly Design Licensing (New Tape Out)

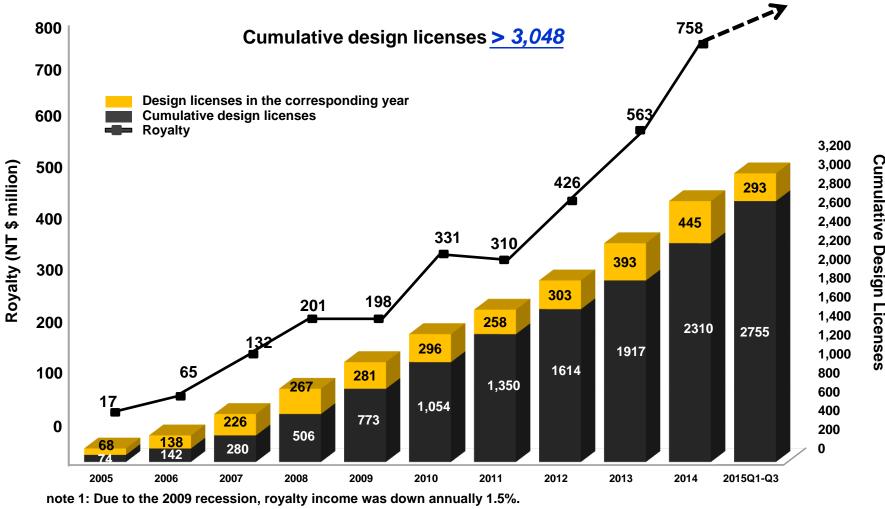
- Total 293 NTO as of Q3 2015 (445@2014 393@2013, 303@2012, 258@2011)



Usage : Usage of pre-qualified and verified IP (charged by per product tape out or annual package), the cycle time from design implementation to royalty payments for mass production is faster, typically less than one year. NRE: NRE covers the customization of IP that must undergo new verification or qualification. It typically requires 1 to 1.5 years before resulting in royalty revenue.



Cumulative Licenses Drive Future Royalties



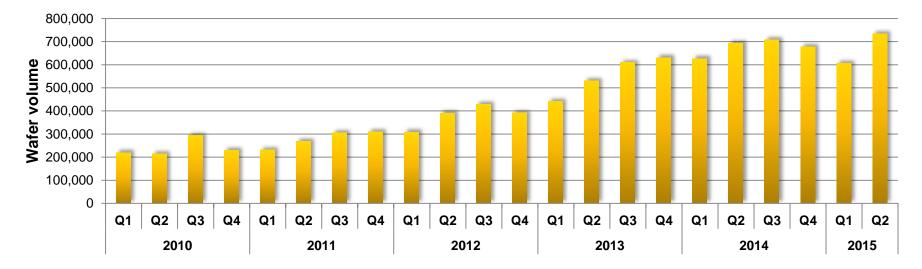
note 2: Pre-payment of royalty fees by a single customer contributed to 2010 annual growth of 67%, causing a drop of 6.3% in the following year, 2011.

note 3: CAGR for 2009-2013 was 30%.

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Wafer Production Volume



embedded eMemory IP in T Company (\$revenue); * % of Process node in T company total revenue in Q315

	Process node	*% of T	Q315	Q215	2014	2013
8"	0.25/0.35	4%	38.2%	34.4%	30.5%	27.3%
	0.15/0.18	12%	7.9%	8.9%	11.9%	10.7%
	0.11/0.13	2%	30.9%	17.0%	20.8%	19.1%
12"	90nm	8%	21.8%	19.2%	16.3%	4.8%
	65nm	11%	0.9%	0.4%	0%	0%
	40/45nm	14%	0%	0%	0%	0%
	28nm	27%	0.02%	0.01%	0%	0%
	16/20nm	21%	0%	0%	0%	0%
8"		19%	16.3%	14.5%	15.6%	14.2%
12"		81%	2.3%	1.8%	1.4%	0.69%
Total		100%	5.0%	4.5%	4.5%	4.1%

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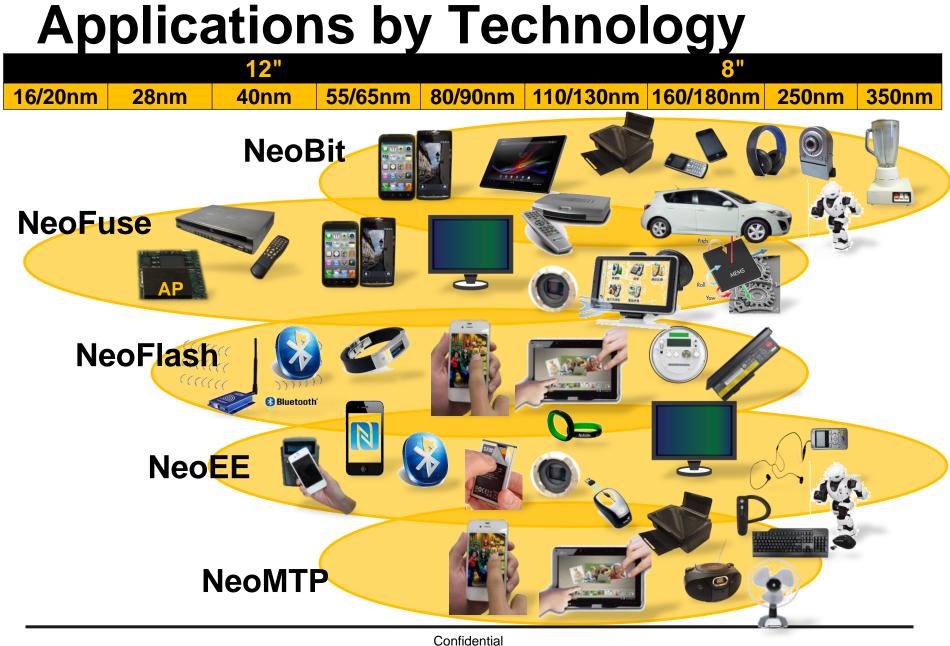
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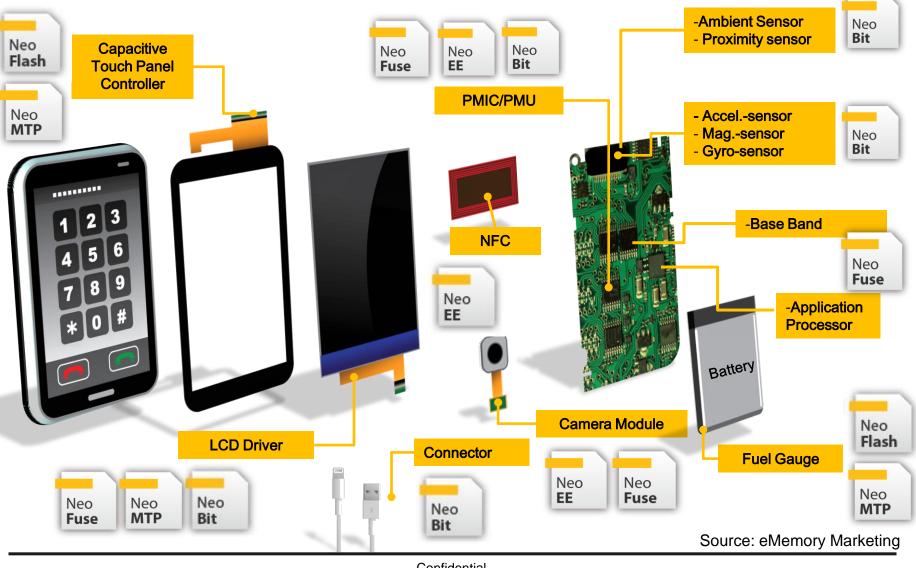


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eMemory IP in Smartphone

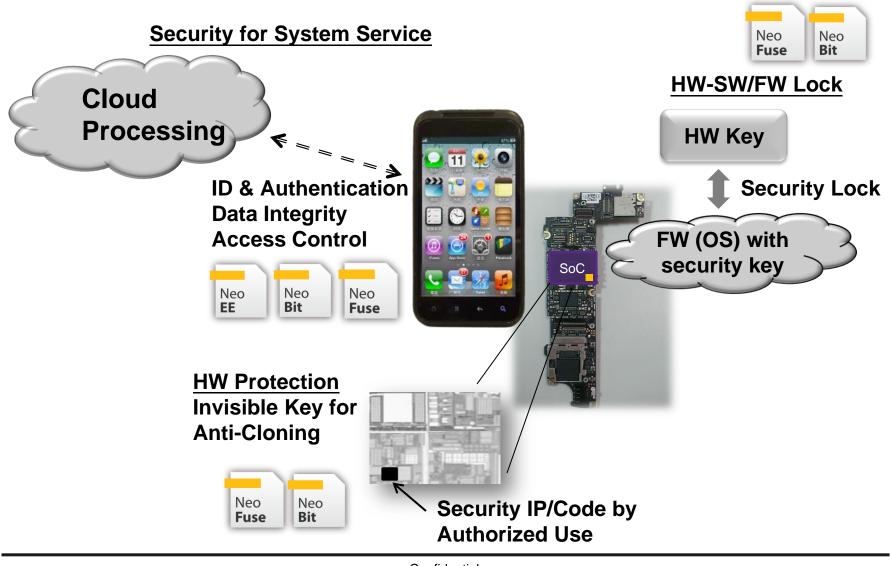


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Security with eMemory IPs

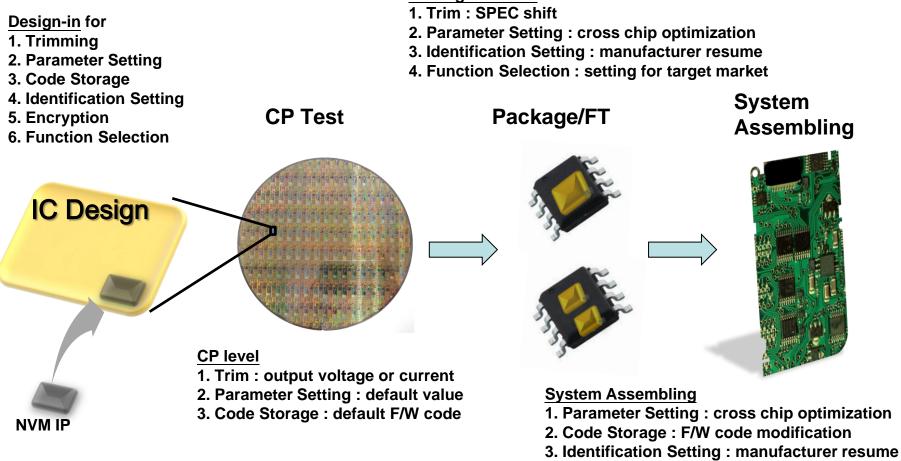


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Benefits from Using eMemory IPs

Package/FT level

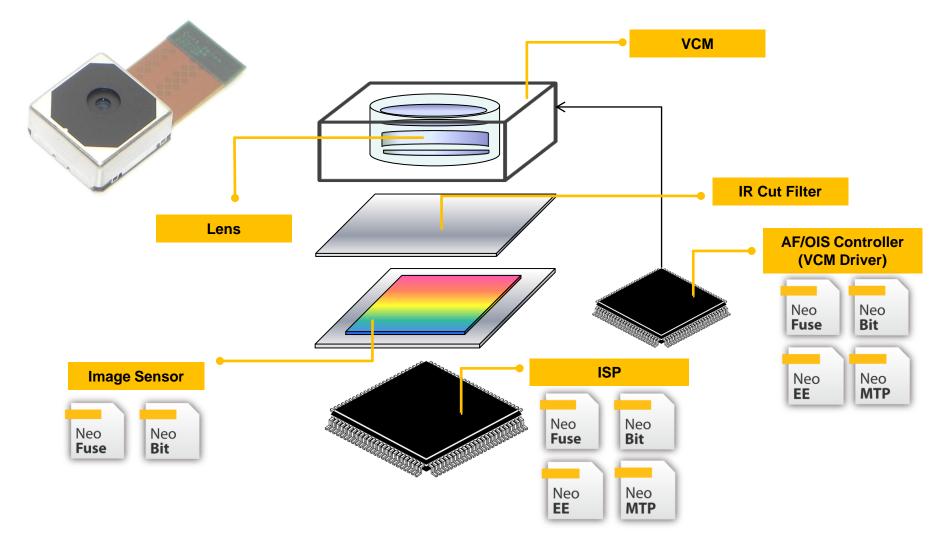


4. Encryption : Security algorithm or key storage

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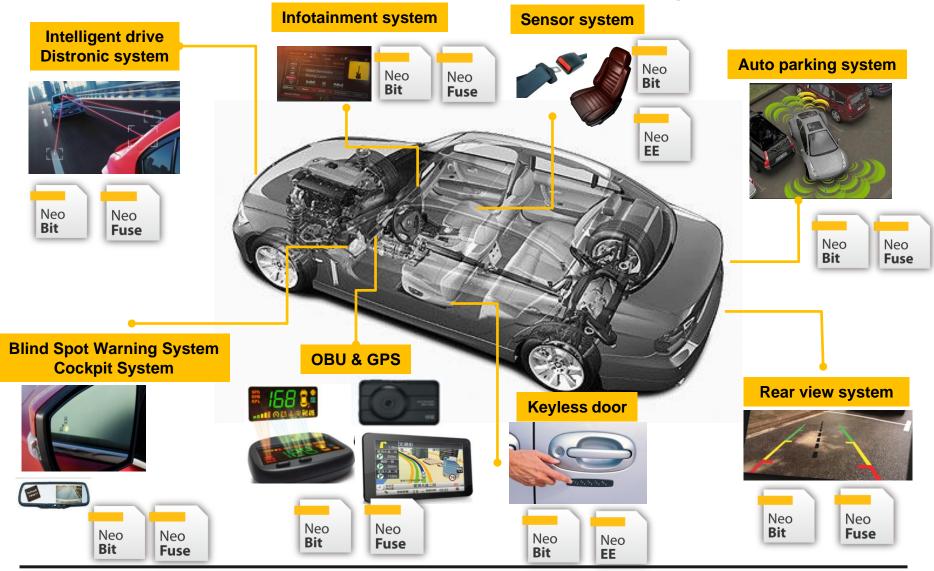
Imager Module with eMemory IPs



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Autotronics with eMemory IPs



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Outlook for Q4 and Beyond

- Several licensing agreements are in final negotiations, and will make a significant contribution to revenue growth.
- Production of PMIC for multiple American and Chinese handset applications continues to expand, and penetrate into other non-handset related applications.
- Advanced 55nm DDI production continues to expand, and new products development begin in 40nm.
- 28nm setup box processors have successfully entered volume production. We are also seeing other customers starting to engage with this technology.

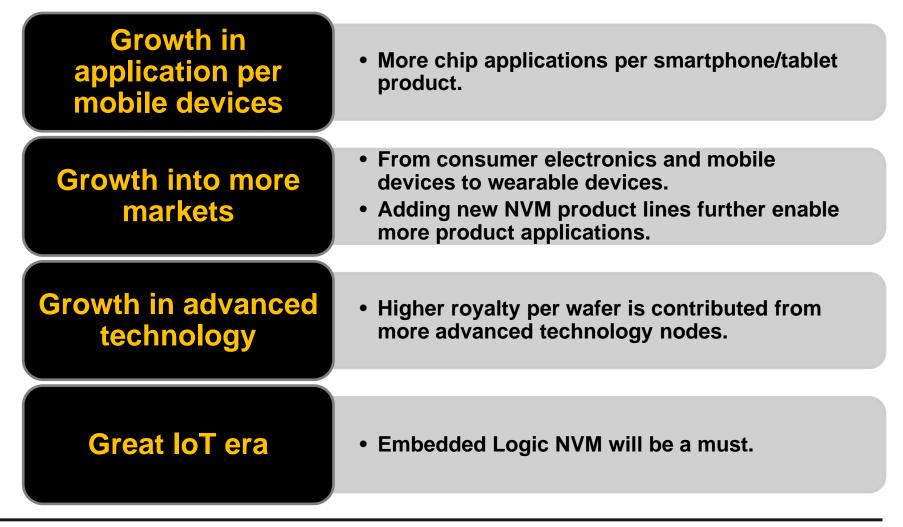


Outlook for Q4 and Beyond

- Customers for fingerprint and CIS continue to tape out.
 We expect production royalties to grow next year as our customers release upgraded product lines.
- 16nm FF⁺ qualification has been successful, and we are in the stages of reliability qualification. We expect customers to tape-out in the first half of 2016.
- European automotive electronics-related products have already taped-out. We are also engaging with Japanese automotive electronics leaders.



Key Growth Drivers





Q & A



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